

# EC200x&EC2x Series

# Compatible Design

**LTE Standard Module Series**

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# About the Document

## Revision History

Version	Date	Author	Description
-	2021-09-27	Kyle CHEN/ Brant WAN/ Dylan LIU	Creation of the document
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# 1 Introduction

Quectel LTE Standard EC200x series modules (EC200U series, EC200T series and EC200S series) are compatible with EC2x series modules (EC25 series, EC21 series, EC20-CE). This document briefly describes the compatible design among EC200x series and EC2x series modules, which can help customers easily migrate from one design to either of the others.

## 1.1. Special Mark

**Table 1: Special Mark**

Mark	Definition
*	Unless otherwise specified, when an asterisk (*) is used after a function, feature, interface, pin name, AT command, or argument, it indicates that the function, feature, interface, pin, AT command, or argument is under development and currently not supported; and the asterisk (*) after a model indicates that the sample of such model is currently unavailable.







# 2 General Descriptions

## 2.1. Product Description

The general information and frequency bands of EC200x and EC2x series modules are presented in the tables below.

### 2.1.1. General Information

Table 2: General Information

Module Name	Appearance	Packaging	Dimensions (mm)
EC200U Series		80 LCC pins + 64 LGA pins	28.0 × 31.0 × 2.4
EC200T Series		80 LCC pins + 64 LGA pins	29.0 × 32.0 × 2.4
EC200S Series		80 LCC pins + 64 LGA pins	29.0 × 32.0 × 2.4
EC25 Series		80 LCC pins + 64 LGA pins	29.0 × 32.0 × 2.4

EC21 Series



80 LCC pins + 64 LGA pins

29.0 × 32.0 × 2.4

EC20-CE



80 LCC pins + 64 LGA pins

29.0 × 32.0 × 2.4

2.1.2. Frequency Bands

Table 3: Frequency Bands

Module	LTE	UMTS	EVDO/CDMA	GSM <sup>1</sup>	Rx-diversity <sup>2</sup>	GNSS
<b>EC200U Series</b>						
EC200U-CN	FDD: B1/B3/B5/B8 TDD: B34/B38/B39/B40/B41	-	-	EGSM900/DCS1800	-	GPS, GLONASS, BeiDou, Galileo, QZSS (Optional)
EC200U-EU	FDD: B1/B3/B5/B7/B8/B20/B28 TDD: B38/B40/B41	-	-	GSM850/EGSM900/DCS1800/PCS1900	-	GPS, GLONASS, BeiDou, Galileo, QZSS (Optional)
<b>EC200T Series</b>						
EC200T-CN	FDD: B1/B3/B5/B8 TDD: B34/B38/B39/B40/B41	WCDMA: B1/B5/B8	-	EGSM900/DCS1800	√	-
EC200T-EU	FDD: B1/B3/B7/B8/B20/B28 TDD: B38/B40/B41	WCDMA: B1/B8	-	EGSM900/DCS1800	√	-
EC200T-AU	FDD: B1/B2/B3/B4/B5/B7/B8/B28/B66 TDD: B40	WCDMA: B1/B2/B4/B5/B8	-	GSM850/EGSM900/DCS1800/PCS1900	√	-
<b>EC200S Series</b>						
EC200S-CN <sup>3</sup>	FDD: B1/B3/B5/B8 TDD: B34/B38/B39/B40/B41	-	-	EGSM900/DCS1800 (Optional)	-	GPS, BeiDou (COMPASS) (Optional)
EC200S-EU	FDD: B1/B3/B5/B7/B8/B20/B28 TDD: B38/B40/B41	-	-	GSM850/EGSM900/DCS1800/PCS1900	-	-
EC200S-EN	FDD: B1/B3/B5/B7/B8/B20/B28/B31/B72	-	-	EGSM900/DCS1800	-	-
EC200S-AU	FDD: B1/B2/B3/B4/B5/B7/B8/B28/B66 TDD: B40	-	-	GSM850/EGSM900/DCS1800/PCS1900	-	-
<b>EC25 Series</b>						
EC25-E	FDD: B1/B3/B5/B7/B8/B20 TDD: B38/B40/B41	WCDMA: B1/B5/B8	-	EGSM900/DCS1800	√	-
EC25-A	FDD: B2/B4/B12	WCDMA: B2/B4/B5	-	-	√	GPS, GLONASS, BeiDou (COMPASS), Galileo, QZSS (Optional)
EC25-V	FDD: B4/B13	-	-	-	√	-
EC25-J	FDD: B1/B3/B8/B18/B19/B26 TDD: B41	WCDMA: B1/B6/B8/B19	-	-	-	-

<sup>1</sup> GSM network on EC200U-CN and EC200S-CN is optional.

<sup>2</sup> Rx-diversity on EC200T series is optional. TD-SCDMA on EC20-CE does not support Rx-diversity.

<sup>3</sup> For EC200S series, only EC200S-CN supports GNSS function.

<b>EC25-AU</b>	FDD: B1/B2 <sup>4</sup> /B3/B4/B5/B7/B8/B28 TDD: B40	WCDMA: B1/B2/B5/B8	-	GSM850/EGSM900/DCS1800/PCS1900	-	
<b>EC25-AUX</b>	FDD: B1/B2 <sup>4</sup> /B3/B4/B5/B7/B8/B28 TDD: B40	WCDMA: B1/B2/B5/B8/B4	-	GSM850/EGSM900/DCS1800/PCS1900	-	
<b>EC25-AF</b>	FDD: B2/B4/B5/B12/B13/B14/B66/B71	WCDMA: B2/B4/B5	-	-	-	
<b>EC25-AFX</b>	FDD: B2/B4/B5/B12/B13/B14/B66/B71	WCDMA: B2/B4/B5	-	-	-	
<b>EC25-EU</b>	FDD: B1/B3/B7/B8/B20/B28A TDD: B38/B40/B41	WCDMA: B1/B8	-	EGSM900/DCS1800	√	
<b>EC25-EUX</b>	FDD: B1/B3/B7/B8/B20/B28A TDD: B38/B40/B41	WCDMA: B1/B8	-	EGSM900/DCS1800	√	
<b>EC25-MX</b>	FDD: B2/B4/B5/B7/B28/B66	WCDMA: B2/B4/B5	-	-	√	-
<b>EC21 Series</b>						
<b>EC21-E</b>	FDD: B1/B3/B5/B7/B8/B20	WCDMA: B1/B5/B8	-	GSM900/DCS1800	√	
<b>EC21-A</b>	FDD: B2/B4/B12	WCDMA: B2/B4/B5	-	-		
<b>EC21-V</b>	FDD: B4/B13	-	-	-		
<b>EC21-AU</b>	FDD: B1/B2 <sup>4</sup> /B3/B4/B5/B7/B8/B28 TDD: B40	WCDMA: B1/B2/B5/B8	-	GSM850/EGSM900/DCS1800/PCS1900		GPS, GLONASS, BeiDou (COMPASS), Galileo, QZSS (Optional)
<b>EC21-EU</b>	FDD: B1/B3/B7/B8/B20/B28A	WCDMA: B1/B8	-	EGSM900/DCS1800	√	
<b>EC21-AUT</b>	FDD: B1/B3/B5/B7/B28	WCDMA: B1/B5	-	-	√	
<b>EC21-EUX</b>	FDD: B1/B3/B7/B8/B20/B28A	WCDMA: B1/B8	-	EGSM900/DCS1800	√	
<b>EC21-J</b>	FDD: B1/B3/B8/B18/B19/B26	-	-	-	√	-
<b>EC21-AUX</b>	FDD: B1/B2 <sup>4</sup> /B3/B4/B5/B7/B8/B28 TDD: B40	WCDMA: B1/B2/B5/B8/B4	-	GSM850/EGSM900/DCS1800/PCS1900	√	-
<b>EC21-KL</b>	FDD: B1/B3/B5/B7/B8	-	-	-	√	-
<b>EC20-CE</b>						
<b>EC20-CE</b>	FDD: B1/B3/B5/B8 TDD: B34/B38/B39/B40/B41	WCDMA: B1/B8 TD-SCDMA: B34/B39	BC0	EGSM900/DCS1800	√	GPS, GLONASS, BeiDou (COMPASS), Galileo, QZSS (Optional)

<sup>4</sup> B2 on EC25-AU/-AUX and EC21-AU/-AUX modules does not support Rx-diversity.

**NOTE**

“√” means supported.

## 2.2. Feature Overview

The general features of EC200x and EC2x series modules are compared in the table below.

**Table 4: Feature Overview**

Feature	EC200U Series	EC200T Series	EC200S Series	EC25 Series/EC21 Series/EC20-CE
Power Supply	Supply voltage: 3.3–4.3 V, Typ. 3.8 V	Supply voltage: 3.4–4.5 V, Typ. 3.8 V	Supply voltage: 3.4–4.5 V, Typ. 3.8 V	Supply voltage: 3.3–4.3 V, Typ. 3.8 V
Sleep Current (USB Suspend)	< 4 mA. For more information, see <a href="#">document [1]</a> .	< 4.1 mA. For more information, see <a href="#">document [2]</a> .	< 4 mA. For more information, see <a href="#">document [3]</a> .	< 4 mA. For more information, see <a href="#">documents [4] &amp; [5] &amp; [6]</a> .
LTE Features	Supports LTE Cat 1: FDD: Max. 10 Mbps (DL), Max. 5 Mbps (UL) TDD: Max. 8.96 Mbps (DL), Max. 3.1 Mbps (UL)	Supports non-CA LTE Cat 4: FDD: Max. 150 Mbps (DL), Max. 50 Mbps (UL) TDD: Max. 130 Mbps (DL), Max. 30 Mbps (UL)	Supports LTE Cat 1: FDD: Max. 10 Mbps (DL), Max. 5 Mbps (UL) TDD: Max. 7.5 Mbps (DL), Max. 1 Mbps (UL)	<b>EC25 Series/EC20-CE:</b> Supports LTE Cat 4: FDD: Max. 150 Mbps (DL), Max. 50 Mbps (UL) TDD: Max. 130 Mbps (DL), Max. 30 Mbps (UL) <b>EC21 Series:</b> Supports LTE Cat 1: FDD: Max. 10 Mbps (DL), Max. 5 Mbps (UL) TDD: Max. 8.96 Mbps (DL), Max. 3.1 Mbps (UL)
Temperature Ranges	Operating temperature range: -35 to +75 °C <sup>5</sup> Extended temperature range: -40 to +85 °C <sup>6</sup> Storage temperature range: -40 to +90 °C	Operating temperature range: -35 to +75 °C <sup>5</sup> Extended temperature range: -40 to +85 °C <sup>6</sup> Storage temperature range: -40 to +90 °C	Operating temperature range: -35 to +75 °C <sup>5</sup> Extended temperature range: -40 to +85 °C <sup>6</sup> Storage temperature range: -40 to +90 °C	Operating temperature range: -35 to +75 °C <sup>5</sup> Extended temperature range: -40 to +85 °C <sup>6</sup> Storage temperature range: -40 to +90 °C
UART Interfaces	<b>Main UART:</b> <ul style="list-style-type: none"> <li>Used for AT command communication and data transmission</li> <li>Baud rates: up to 921600 bps, 115200 bps by default</li> <li>RTS and CTS hardware flow control</li> </ul> <b>Debug UART:</b> <ul style="list-style-type: none"> <li>Used for outputting partial logs</li> <li>921600 bps baud rate</li> <li>Used for debug UART interface only</li> </ul> <b>Auxiliary UART</b>	<b>Main UART:</b> <ul style="list-style-type: none"> <li>Used for AT command communication and data transmission</li> <li>Baud rates: up to 1 Mbps, 115200 bps by default</li> <li>RTS and CTS hardware flow control</li> </ul> <b>Debug UART:</b> <ul style="list-style-type: none"> <li>Used for outputting partial logs</li> <li>115200 bps baud rate</li> </ul>	<b>Main UART:</b> <ul style="list-style-type: none"> <li>Used for AT command communication and data transmission</li> <li>Baud rates: up to 1 Mbps, 115200 bps by default</li> <li>RTS and CTS hardware flow control</li> </ul> <b>Debug UART:</b> <ul style="list-style-type: none"> <li>Used for outputting partial logs</li> <li>115200 bps baud rate</li> </ul>	<b>Main UART:</b> <ul style="list-style-type: none"> <li>Used for AT command communication and data transmission</li> <li>Baud rates: up to 921600 bps, 115200 bps by default</li> <li>RTS and CTS hardware flow control</li> </ul> <b>Debug UART:</b> <ul style="list-style-type: none"> <li>Used for Linux console and log output</li> <li>115200 bps baud rate</li> </ul>

<sup>5</sup> Within the operating temperature range, the module meets 3GPP specifications.

<sup>6</sup> Within the extended temperature range, the module retains the functionalities such as voice, SMS, data transmission, etc., without any unrecoverable malfunction. Radio spectrum and radio network are not influenced, while one or more specification, such as P<sub>out</sub>, may exceed the specified 3GPP tolerances. When the temperature returns to the operating temperature range, the module meets 3GPP specifications again.

USB Interface	USB 2.0 high-speed and full-speed (slave only) supported	USB 2.0 high-speed and full-speed (slave only) supported	USB 2.0 high-speed and full-speed (slave only) supported	USB 2.0 high-speed (slave only) supported
Digital Audio	PCM interface (slave only)	PCM interface	PCM interface	PCM interface
I2C Interfaces	Supported	Supported	Supported	Supported
SD Card Interface	SD 2.0 protocol	SD 3.0 protocol	SD 3.0 protocol *	SD 3.0 protocol
WLAN/Bluetooth Interface	SDIO 2.0 interface for WLAN* (Wi-Fi-scan and Bluetooth share the same antenna interface)	SDIO 3.0 interface for WLAN* (Bluetooth function is not supported)	SDIO 3.0 interface for WLAN* (Bluetooth function is not supported)	Low-power SDIO 3.0 interface for WLAN; UART & PCM interfaces for Bluetooth
SGMII Interface	-	-	-	10 Mbps/100 Mbps/1000 Mbps Ethernet work modes <b>EC25 Series/EC20-CE:</b> Max. 150 Mbps (DL)/50 Mbps (UL) for 4G network <b>EC21 Series:</b> Max. 10 Mbps (DL)/Max. 5 Mbps (UL) for 4G network
(U)SIM Card Detection	Supported	Supported	Supported	Supported
GNSS <sup>7</sup>	GPS, GLONASS, BeiDou, Galileo, QZSS (Optional)	-	GPS, BeiDou (COMPASS) (Optional)	GPS, GLONASS, BeiDou (COMPASS), Galileo, QZSS (Optional)
Firmware Upgrade	Via USB interface or FOTA	USB interface or FOTA	USB interface or DFOTA	USB interface or DFOTA

<sup>7</sup> For EC200S series, only EC200S-CN supports GNSS function.

### 2.3. Pin Assignment

Pin assignments of EC200x and EC2x series modules are presented in the figures below.

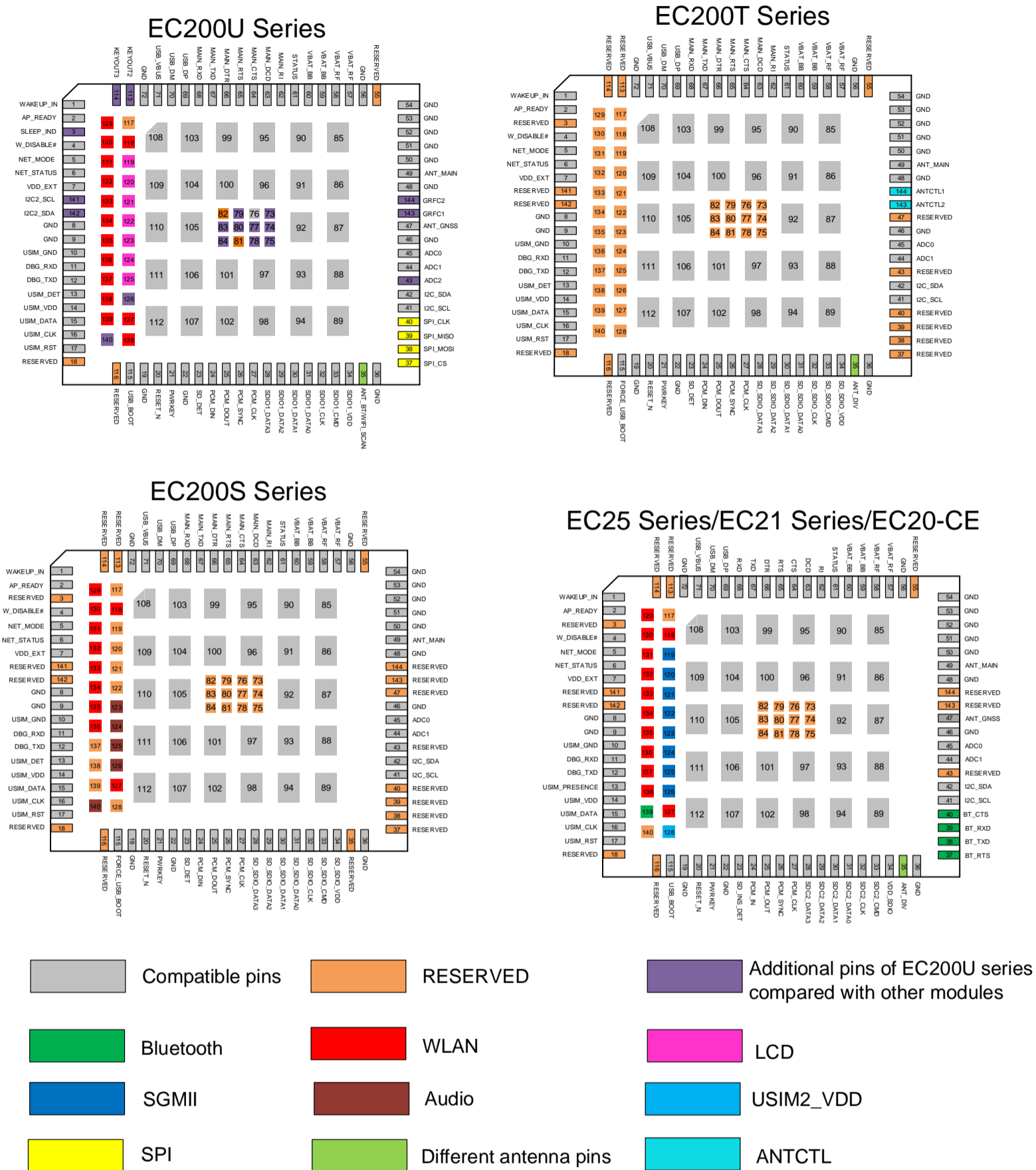


Figure 1: EC200x & EC2x Series Pin Assignment

**NOTE**

1. The USB\_BOOT/FORCE\_USB\_BOOT pin on the EC200U/EC200T series cannot be pulled up before the module is successfully powered on. In addition, the KEYIN1 pin on EC200U series cannot be pulled up before startup. There are no restrictions on other pins.
2. WAKEUP\_IN (pin 1), NET\_STATUS (pin 6) and FORCE\_USB\_BOOT (pin 115) should not be pulled up high before the module is successfully started up. Pin 47 is the ANT\_GNSS pin on EC200S-CN with built-in GNSS function and the RESERVED pin on other variants of EC200S series.
3. WAKEUP\_IN, NET\_MODE, WLAN\_EN, COEX\_UART\_RX, COEX\_UART\_TX, USB\_BOOT, BT\_CTS pins on EC25 series/EC21 series/EC20-CE cannot be pulled up before startup.

# 3 Pin Description

The pins on EC200x and EC2x series modules are described in this chapter.

**Table 5: I/O Parameter Definition**

Symbol	Description
AI	Analog Input
AO	Analog Output
AIO	Analog Input/Output
DI	Digital Input
DO	Digital Output
DIO	Digital Input/Output
OD	Open Drain
PI	Power Input
PO	Power Output



### 3.1. Pin Description

Pin definition of EC200x and EC2x series modules is presented in the following table.

**Table 6: Pin Definition**

EC200U Series				EC200T Series				EC200S Series				EC25 Series/EC21 Series/EC20-CE			
Pin No.	Pin Name	I/O	Power Domain	Pin No.	Pin Name	I/O	Power Domain	Pin No.	Pin Name	I/O	Power Domain	Pin No.	Pin Name	I/O	Power Domain
1	WAKEUP_IN	DI	1.8 V	1	WAKEUP_IN*	DI	1.8 V	1	WAKEUP_IN	DI	1.8 V	1	WAKEUP_IN	DI	1.8 V
2	AP_READY	DI	1.8 V	2	AP_READY	DI	1.8 V	2	AP_READY	DI	1.8 V	2	AP_READY	DI	1.8 V
3	SLEEP_IND	DO	1.8 V	3	RESERVED	-	-	3	RESERVED	-	-	3	RESERVED	-	-
4	W_DISABLE#	DI	1.8 V	4	W_DISABLE#	DI	1.8 V	4	W_DISABLE#	DI	1.8 V	4	W_DISABLE#	DI	1.8 V
5	NET_MODE	DO	1.8 V	5	NET_MODE	DO	1.8 V	5	NET_MODE	DO	1.8 V	5	NET_MODE	DO	1.8 V
6	NET_STATUS	DO	1.8 V	6	NET_STATUS	DO	1.8 V	6	NET_STATUS	DO	1.8 V	6	NET_STATUS	DO	1.8 V
7	VDD_EXT	PO	1.8 V	7	VDD_EXT	PO	1.8 V	7	VDD_EXT	PO	1.8 V	7	VDD_EXT	PO	1.8 V
8	GND	-	GND	8	GND	-	GND	8	GND	-	GND	8	GND	-	GND
9	GND	-	GND	9	GND	-	GND	9	GND	-	GND	9	GND	-	GND
10	USIM_GND	-	GND	10	USIM_GND	-	GND	10	USIM_GND	-	GND	10	USIM_GND	-	GND
11	DBG_RXD	DI	1.8 V	11	DBG_RXD	DI	1.8 V	11	DBG_RXD	DI	1.8 V	11	DBG_RXD	DI	1.8 V
12	DBG_TXD	DO	1.8 V	12	DBG_TXD	DO	1.8 V	12	DBG_TXD	DO	1.8 V	12	DBG_TXD	DO	1.8 V
13	USIM_DET	DI	1.8 V	13	USIM_DET	DI	1.8 V	13	USIM_DET	DI	1.8 V	13	USIM_PRESENCE	DI	1.8 V
14	USIM_VDD	PO	1.8/3.0 V	14	USIM_VDD	PO	1.8/3.0 V	14	USIM_VDD	PO	1.8/3.0 V	14	USIM_VDD	PO	1.8/3.0 V
15	USIM_DATA	DIO	1.8/3.0 V	15	USIM_DATA	DIO	1.8/3.0 V	15	USIM_DATA	DIO	1.8/3.0 V	15	USIM_DATA	DIO	1.8/3.0 V
16	USIM_CLK	DO	1.8/3.0 V	16	USIM_CLK	DO	1.8/3.0 V	16	USIM_CLK	DO	1.8/3.0 V	16	USIM_CLK	DO	1.8/3.0 V
17	USIM_RST	DO	1.8/3.0 V	17	USIM_RST	DO	1.8/3.0 V	17	USIM_RST	DO	1.8/3.0 V	17	USIM_RST	DO	1.8/3.0 V
19	GND	-	GND	19	GND	-	GND	19	GND	-	GND	19	GND	-	GND
20	RESET_N	DI	VBAT Voltage domain	20	RESET_N	DI	1.8 V	20	RESET_N	DI	1.8 V	20	RESET_N	DI	1.8 V

21	PWRKEY	DI	VBAT Voltage domain	21	PWRKEY	DI	VBAT	21	PWRKEY	DI	VBAT	21	PWRKEY	DI	The output voltage is 0.8 V when the module is powered on.
22	GND	-	GND	22	GND	-	GND	22	GND	-	GND	22	GND	-	GND
23	SD_DET	DI	1.8 V	23	SD_DET*	DI	1.8/2.8 V	23	SD_DET*	DI	1.8/2.8 V	23	SD_INS_DET	DI	1.8 V
24	PCM_DIN	DI	1.8 V	24	PCM_DIN	DI	1.8 V	24	PCM_DIN	DI	1.8 V	24	PCM_IN	DI	1.8 V
25	PCM_DOUT	DO	1.8 V	25	PCM_DOUT	DO	1.8 V	25	PCM_DOUT	DO	1.8 V	25	PCM_OUT	DO	1.8 V
26	PCM_SYNC	DI	1.8 V	26	PCM_SYNC	DIO	1.8 V	26	PCM_SYNC	DIO	1.8 V	26	PCM_SYNC	DIO	1.8 V
27	PCM_CLK	DI	1.8 V	27	PCM_CLK	DIO	1.8 V	27	PCM_CLK	DIO	1.8 V	27	PCM_CLK	DIO	1.8 V
28	SDIO1_DATA3	DIO	1.8/3.2 V	28	SD_SDIO_DATA3	DIO	1.8/2.8 V	28	SD_SDIO_DATA3*	DIO	1.8/2.8 V	28	SDC2_DATA3	DIO	1.8/2.85 V
29	SDIO1_DATA2	DIO	1.8/3.2 V	29	SD_SDIO_DATA2	DIO	1.8/2.8 V	29	SD_SDIO_DATA2*	DIO	1.8/2.8 V	29	SDC2_DATA2	DIO	1.8/2.85 V
30	SDIO1_DATA1	DIO	1.8/3.2 V	30	SD_SDIO_DATA1	DIO	1.8/2.8 V	30	SD_SDIO_DATA1*	DIO	1.8/2.8 V	30	SDC2_DATA1	DIO	1.8/2.85 V
31	SDIO1_DATA0	DIO	1.8/3.2 V	31	SD_SDIO_DATA0	DIO	1.8/2.8 V	31	SD_SDIO_DATA0*	DIO	1.8/2.8 V	31	SDC2_DATA0	DIO	1.8/2.85 V
32	SDIO1_CLK	DO	1.8/3.2 V	32	SD_SDIO_CLK	DO	1.8/2.8 V	32	SD_SDIO_CLK*	DO	1.8/2.8 V	32	SDC2_CLK	DO	1.8/2.85 V
33	SDIO1_CMD	DIO	1.8/3.2 V	33	SD_SDIO_CMD	DIO	1.8/2.8 V	33	SD_SDIO_CMD*	DIO	1.8/2.8 V	33	SDC2_CMD	DIO	1.8/2.85 V
34	SDIO1_VDD	PO	1.8/3.2 V	34	SD_SDIO_VDD	PO	1.8/2.8 V	34	SD_SDIO_VDD*	PO	1.8/2.8 V	34	VDD_SDIO	PO	1.8/2.85 V
35	ANT_BT/ WIFI_SCAN	AIO	-	35	ANT_DIV	AI	-	35	RESERVED	-	-	35	ANT_DIV	AI	-
36	GND	-	GND	36	GND	-	GND	36	GND	-	GND	36	GND	-	GND
37	SPI_CS	DO	-	37	RESERVED	-	-	37	RESERVED	-	-	37	BT_RTS	DI	1.8 V
38	SPI_MOSI	DO	-	38	RESERVED	-	-	38	RESERVED	-	-	38	BT_TXD	DO	1.8 V
39	SPI_MISO	DI	-	39	RESERVED	-	-	39	RESERVED	-	-	39	BT_RXD	DI	1.8 V
40	SPI_CLK	DO	-	40	RESERVED	-	-	40	RESERVED	-	-	40	BT_CTS	DO	1.8 V
41	I2C_SCL	OD	An external 1.8 V pull-up resistor is required.	41	I2C_SCL	OD	An external 1.8 V pull-up resistor is required.	41	I2C_SCL	OD	An external 1.8 V pull-up resistor is required.	41	I2C_SCL	OD	An external 1.8 V pull-up resistor is required.
42	I2C_SDA	OD	An external 1.8 V pull-up resistor is required.	42	I2C_SDA	OD	An external 1.8 V pull-up resistor is required.	42	I2C_SDA	OD	An external 1.8 V pull-up resistor is required.	42	I2C_SDA	OD	An external 1.8 V pull-up resistor is required.

43	ADC2	AI	0-VBAT_BB	43	RESERVED	-	-	43	RESERVED	-	-	43	RESERVED	-	-
44	ADC1	AI	0-VBAT_BB	44	ADC1	AI	0-VBAT_BB	44	ADC1	AI	0-VBAT_BB	44	ADC1	AI	0.3 V-VBAT_BB
45	ADC0	AI	0-VBAT_BB	45	ADC0	AI	0-VBAT_BB	45	ADC0	AI	0-VBAT_BB	45	ADC0	AI	0.3 V-VBAT_BB
46	GND	-	GND	46	GND	-	GND	46	GND	-	GND	46	GND	-	GND
47	ANT_GNSS	AI	-	47	RESERVED	-	-	47	RESERVED <sup>8</sup>	-	-	47	ANT_GNSS	AI	-
48	GND	-	GND	48	GND	-	GND	48	GND	-	GND	48	GND	-	GND
49	ANT_MAIN	AIO	-	49	ANT_MAIN	AIO	-	49	ANT_MAIN	AIO	-	49	ANT_MAIN	AIO	-
50-54	GND	-	GND	50-54	GND	-	GND	50-54	GND	-	GND	50-54	GND	-	GND
56	GND	-	GND	56	GND	-	GND	56	GND	-	GND	56	GND	-	GND
57	VBAT_RF	PI	3.3-4.3 V	57	VBAT_RF	PI	3.4-4.5 V	57	VBAT_RF	PI	3.4-4.5 V	57	VBAT_RF	PI	3.3-4.3 V
58	VBAT_RF	PI	3.3-4.3 V	58	VBAT_RF	PI	3.4-4.5 V	58	VBAT_RF	PI	3.4-4.5 V	58	VBAT_RF	PI	3.3-4.3 V
59	VBAT_BB	PI	3.3-4.3 V	59	VBAT_BB	PI	3.4-4.5 V	59	VBAT_BB	PI	3.4-4.5 V	59	VBAT_BB	PI	3.3-4.3 V
60	VBAT_BB	PI	3.3-4.3 V	60	VBAT_BB	PI	3.4-4.5 V	60	VBAT_BB	PI	3.4-4.5 V	60	VBAT_BB	PI	3.3-4.3 V
61	STATUS	DO	1.8 V	61	STATUS	OD	-	61	STATUS	OD	-	61	STATUS	OD	-
62	MAIN_RI	DO	1.8 V	62	MAIN_RI	DO	1.8 V	62	MAIN_RI	DO	1.8 V	62	RI	DO	1.8 V
63	MAIN_DCD	DO	1.8 V	63	MAIN_DCD	DO	1.8 V	63	MAIN_DCD	DO	1.8 V	63	DCD	DO	1.8 V
64	MAIN_CTS	DO	1.8 V	64	MAIN_CTS	DO	1.8 V	64	MAIN_CTS	DO	1.8 V	64	CTS	DO	1.8 V
65	MAIN_RTS	DI	1.8 V	65	MAIN_RTS	DI	1.8 V	65	MAIN_RTS	DI	1.8 V	65	RTS	DI	1.8 V
66	MAIN_DTR	DI	1.8 V	66	MAIN_DTR	DI	1.8 V	66	MAIN_DTR	DI	1.8 V	66	DTR	DI	1.8 V
67	MAIN_TXD	DO	1.8 V	67	MAIN_TXD	DO	1.8 V	67	MAIN_TXD	DO	1.8 V	67	TXD	DO	1.8 V
68	MAIN_RXD	DI	1.8 V	68	MAIN_RXD	DI	1.8 V	68	MAIN_RXD	DI	1.8 V	68	RXD	DI	1.8 V
69	USB_DP	AIO	-	69	USB_DP	AIO	-	69	USB_DP	AIO	-	69	USB_DP	AIO	-
70	USB_DM	AIO	-	70	USB_DM	AIO	-	70	USB_DM	AIO	-	70	USB_DM	AIO	-
71	USB_VBUS	AI	3.5-5.25 V	71	USB_VBUS	AI	3.0-5.25 V	71	USB_VBUS	AI	3.0-5.25 V	71	USB_VBUS	AI	3.0-5.25 V
72	GND	-	GND	72	GND	-	GND	72	GND	-	GND	72	GND	-	GND
73	LOUDSPK_P	AO	-	73	RESERVED	-	-	73	RESERVED	-	-	73	RESERVED	-	-

<sup>8</sup> Pin 47 is the ANT\_GNSS pin on EC200S-CN with built-in GNSS function and it is the RESERVED pin on other variants of EC200S series.

74	LOUDSPK_N	AO	-	74	RESERVED	-	-	74	RESERVED	-	-	74	RESERVED	-	-
75	MIC_P	AI	-	75	RESERVED	-	-	75	RESERVED	-	-	75	RESERVED	-	-
76	GND	-	GND	76	RESERVED	-	-	76	RESERVED	-	-	76	RESERVED	-	-
77	MIC_N	AI	-	77	RESERVED	-	-	77	RESERVED	-	-	77	RESERVED	-	-
78	KEYIN1	DI	1.8 V	78	RESERVED	-	-	78	RESERVED	-	-	78	RESERVED	-	-
79	KEYIN2	DI	1.8 V	79	RESERVED	-	-	79	RESERVED	-	-	79	RESERVED	-	-
80	KEYIN3	DI	1.8 V	80	RESERVED	-	-	80	RESERVED	-	-	80	RESERVED	-	-
83	KEYOUT0	DO	1.8 V	83	RESERVED	-	-	83	RESERVED	-	-	83	RESERVED	-	-
84	KEYOUT1	DO	1.8 V	84	RESERVED	-	-	84	RESERVED	-	-	84	RESERVED	-	-
85–112	GND	-	GND	85–112	GND	-	GND	85–112	GND	-	GND	85–112	GND	-	GND
113	KEYOUT2	DO	1.8 V	113	RESERVED	-	-	113	RESERVED	-	-	113	RESERVED	-	-
114	KEYOUT3	DO	1.8 V	114	RESERVED	-	-	114	RESERVED	-	-	114	RESERVED	-	-
115	USB_BOOT	DI	1.8 V	115	FORCE_USB_BOOT	DI	1.8 V	115	FORCE_USB_BOOT	DI	1.8 V	115	USB_BOOT	DI	1.8 V
118	WLAN_SLP_CLK*	DO	1.8 V	118	RESERVED	DO	1.8 V	118	WLAN_SLP_CLK*	DO	1.8 V	118	WLAN_SLP_CLK	DO	1.8 V
119	LCD_FMARK	DI	1.8 V	119	RESERVED	-	-	119	RESERVED	-	-	119	EPHY_RST_N	DO	1.8/2.85 V
120	LCD_RSTB	DO	1.8 V	120	RESERVED	-	-	120	RESERVED	-	-	120	EPHY_INT_N	DI	1.8 V
121	LCD_SEL	-	1.8 V	121	RESERVED	-	-	121	RESERVED	-	-	121	SGMII_MDATA	DIO	1.8/2.85 V
122	LCD_CS	DO	1.8 V	122	RESERVED	-	-	122	RESERVED	-	-	122	SGMII_MCLK	DO	1.8/2.85 V
123	LCD_CLK	DO	1.8 V	123	RESERVED	-	-	123	SPK_N	AO	-	123	SGMII_TX_M	AO	-
124	LCD_SDC	DO	1.8 V	124	RESERVED	-	-	124	SPK_P	AO	-	124	SGMII_TX_P	AO	-
125	LCD_S/I/O	DIO	-	125	RESERVED	-	-	125	MIC_P	AI	-	125	SGMII_RX_P	AI	-
126	GPIO1	DO	-	126	RESERVED	-	-	126	MIC_N	AI	-	126	SGMII_RX_M	AI	-
127	WLAN_PWR_EN*	DO	1.8 V	127	RESERVED	DO	1.8 V	127	WLAN_PWR_EN*	DO	1.8 V	127	PM_ENABLE	DO	1.8 V
128	USIM2_VDD	PO	1.8/3.0 V	128	RESERVED	-	-	128	RESERVED	-	-	128	USIM2_VDD	PO	1.8/2.85 V
129	SDIO2_DATA3*	DIO	1.8 V	129	RESERVED	DIO	1.8 V	129	WLAN_SDIO_DATA3*	DIO	1.8 V	129	SDC1_DATA3	DIO	1.8 V
130	SDIO2_DATA2*	DIO	1.8 V	130	RESERVED	DIO	1.8 V	130	WLAN_SDIO_DATA2*	DIO	1.8 V	130	SDC1_DATA2	DIO	1.8 V
131	SDIO2_DATA1*	DIO	1.8 V	131	RESERVED	DIO	1.8 V	131	WLAN_SDIO_DATA1*	DIO	1.8 V	131	SDC1_DATA1	DIO	1.8 V
132	SDIO2_DATA0*	DIO	1.8 V	132	RESERVED	DIO	1.8 V	132	WLAN_SDIO_DATA0*	DIO	1.8 V	132	SDC1_DATA0	DIO	1.8 V

133	SDIO2_CLK*	DO	1.8 V	133	RESERVED	DO	1.8 V	133	WLAN_SDIO_CLK*	DO	1.8 V	133	SDC1_CLK	DO	1.8 V
134	SDIO2_CMD*	DO	1.8 V	134	RESERVED	DO	1.8 V	134	WLAN_SDIO_CMD*	DO	1.8 V	134	SDC1_CMD	DO	1.8 V
135	WLAN_WAKE*	DI	1.8 V	135	RESERVED	DI	1.8 V	135	WLAN_WAKE*	DI	1.8 V	135	WAKE_ON_WIRELESS	DI	1.8 V
136	WLAN_EN*	DO	1.8 V	136	RESERVED	DO	1.8 V	136	WLAN_EN*	DO	1.8 V	136	WLAN_EN	DO	1.8 V
137	AUX_RXD	DI	1.8 V	137	RESERVED	-	-	137	RESERVED	-	-	137	COEX_UART_RX	DI	1.8 V
138	AUX_TXD	DO	1.8 V	138	RESERVED	-	-	138	RESERVED	-	-	138	COEX_UART_TX	DO	1.8 V
139	BT_EN	DO	1.8 V	139	RESERVED	-	-	139	RESERVED	-	-	139	BT_EN	DO	1.8 V
140	ISINK	PI	-	140	RESERVED	-	-	140	MICBIAS	PO	-	140	RESERVED	-	-
141	I2C2_SCL	OD	An external 1.8 V pull-up resistor is required.	141	RESERVED	-	-	141	RESERVED	-	-	141	RESERVED	-	-
142	I2C2_SDA	OD	An external 1.8 V pull-up resistor is required.	142	RESERVED	-	-	142	RESERVED	-	-	142	RESERVED	-	-
143	GRFC1	DO	1.8 V	143	ANTCTL2	DO	-	143	RESERVED	-	-	143	RESERVED	-	-
144	GRFC2	DO	1.8 V	144	ANTCTL1	DO	-	144	RESERVED	-	-	144	RESERVED	-	-
18, 55, 81, 82, 116, 117	RESERVED	-	-	18, 55, 81, 82, 116, 117	RESERVED	-	-	18, 55, 81, 82, 116, 117	RESERVED	-	-	18, 55, 81, 82, 116, 117	RESERVED	-	-

**NOTE**

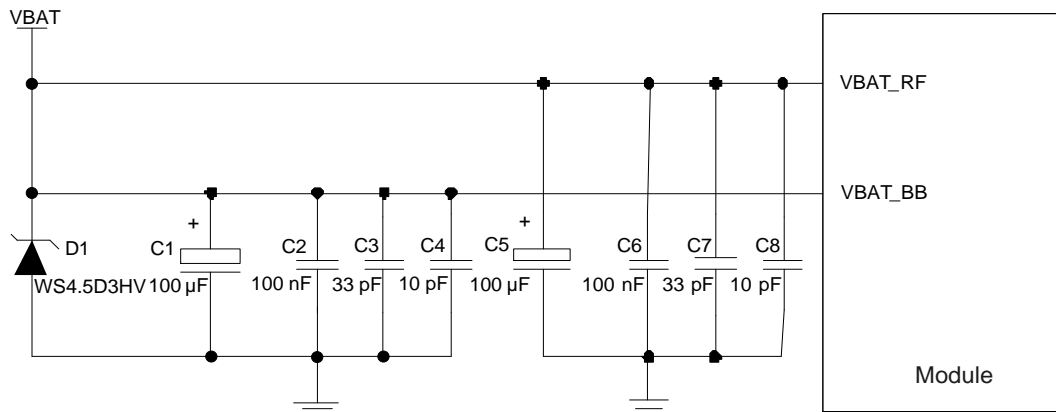
1. Keep all reserved and unused pins unconnected.
2. All GND pins should be connected to ground.
3. For comprehensive and detailed definitions of Wi-Fi & Bluetooth and SGMII functions on pins 118–139, see *document [1] & [2] & [3] & [4] & [5] & [6]*.
4. Pins in blue are pins with different functions or voltage domain, but the module footprint is compatible.

# 4 Hardware Reference Design

The following sub-chapters describe the compatible design among EC200x and EC2x series modules in terms of main functionalities.

## 4.1. Power Supply

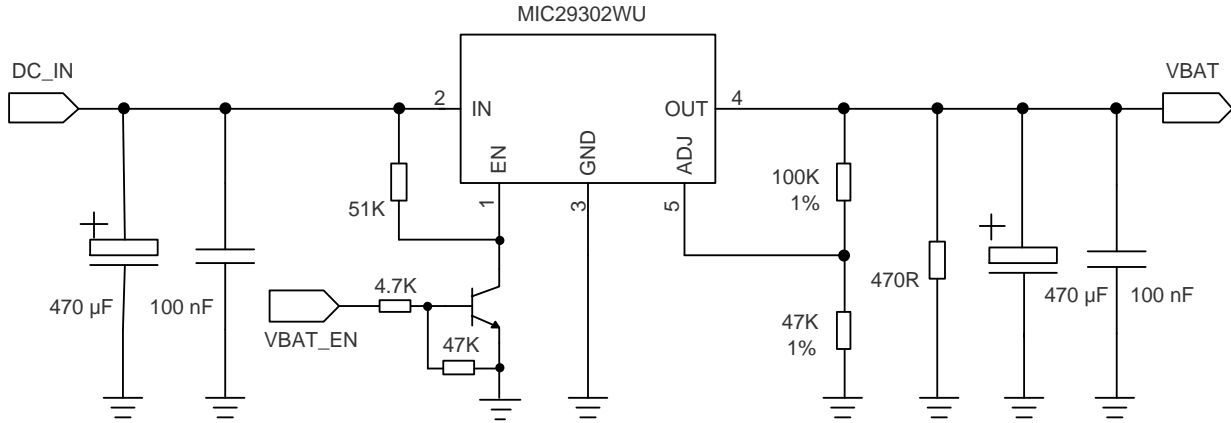
Use a TVS diode with low reverse stand-off voltage  $V_{RWM}$ , low clamping voltage  $V_C$  and high reverse peak pulse current  $I_{PP}$  to ensure power source stability. A reference design for +5.0 V input power source and the power supply in star-shaped pattern are presented in the figure below.



**Figure 2: Power Supply in Star-Shaped Pattern**

The performance of the module largely depends on the power source. The power supply for EC200x series and EC2x series should be able to provide sufficient current up to 2.0 A. For EC200U-CN and EC200S-CN, on which GSM is an option, the power supply should provide up to 2.0 A to the variant that supports only LTE network, while 3.0 A should be provided for the variant that supports GSM network, as well.

A reference design for + 5.0 V input power source is presented in the figure below. The typical output of the power supply is about 3.8 V and the maximum load current is 3.0 A.

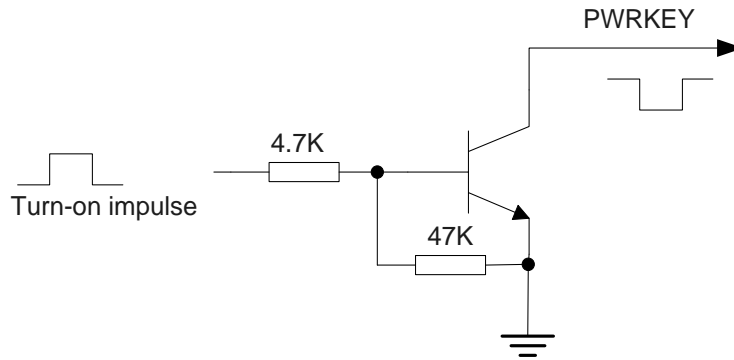


**Figure 3: Power Supply Reference Design**

## 4.2. Turn-on/off

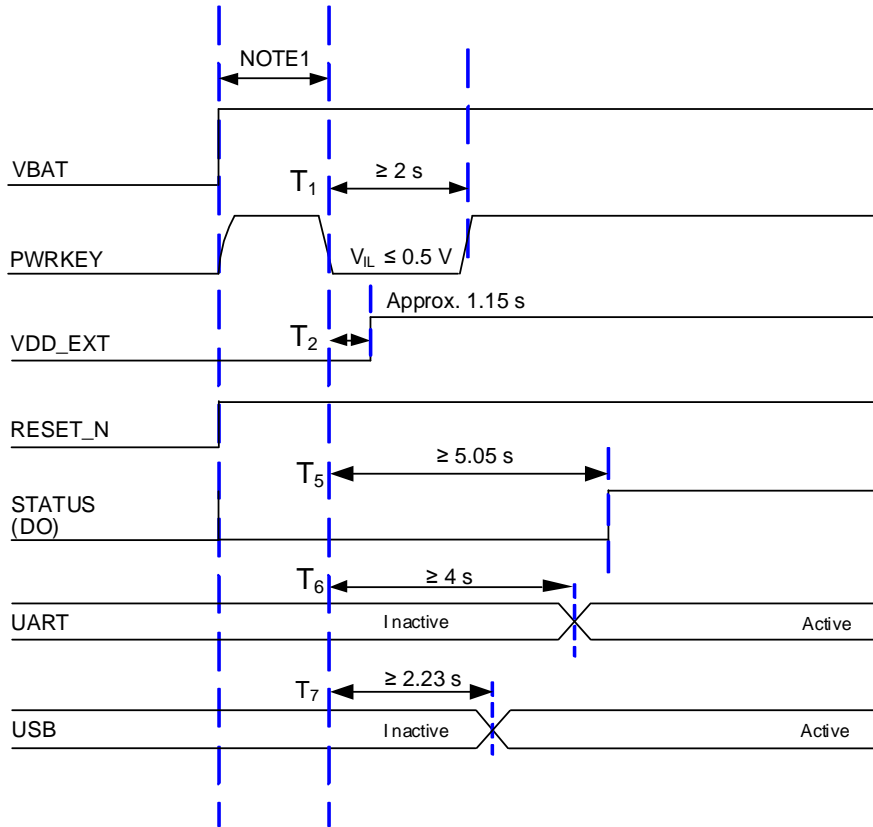
### 4.2.1. Turn-on

A reference design for the turn-on circuits of EC200x and EC2x series modules is presented in the figure below.



**Figure 4: Turn-on Circuit**

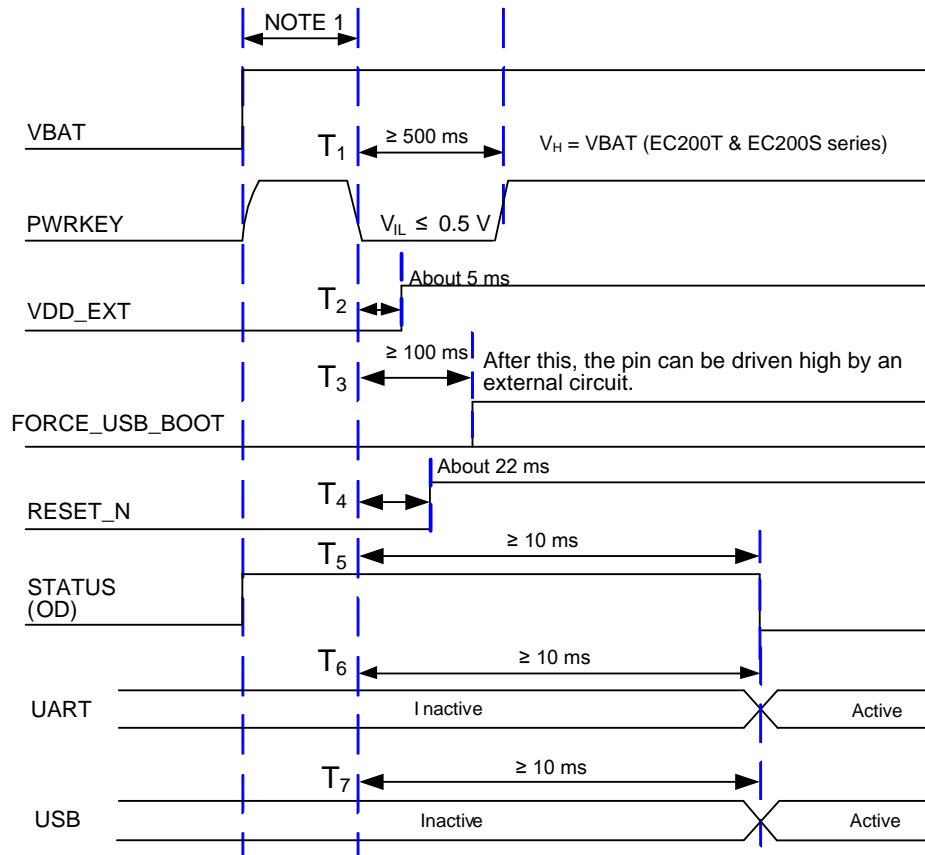
The power-up scenario of EC200U series modules is illustrated in the figure below.



**Figure 5: Power-up Timing (EC200U Series)**

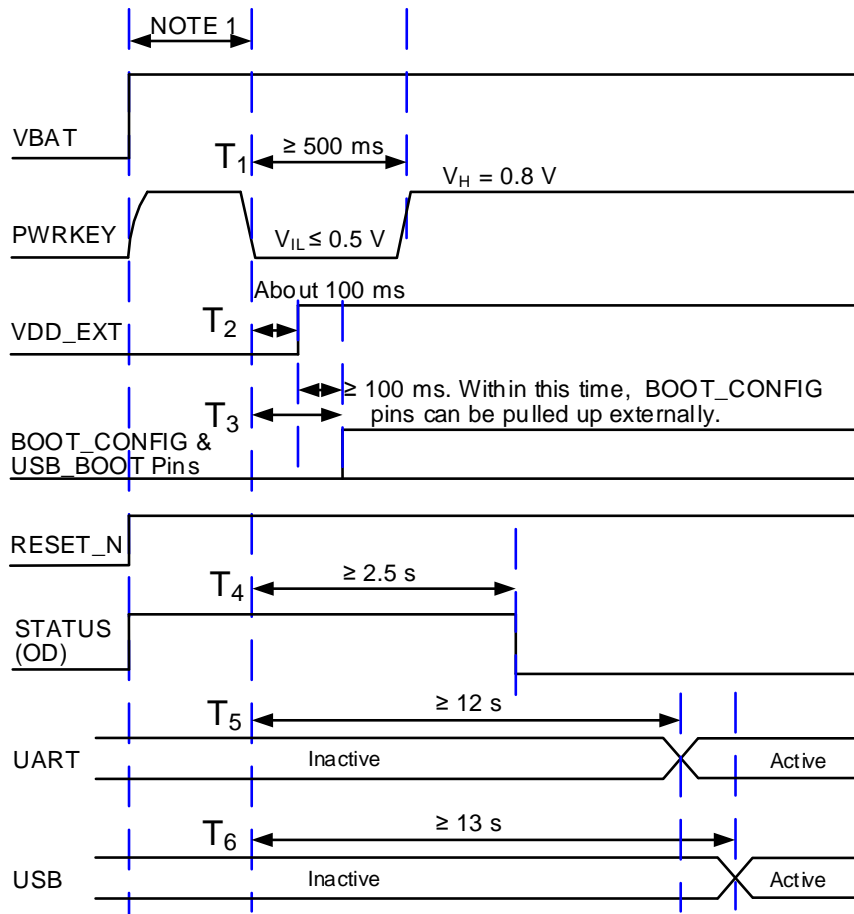


The power-up scenario of EC200T series, EC200S series modules is illustrated in the figure below.



**Figure 6: Power-up Timing (EC200T & EC200S Series)**

The power-up scenario of EC2x series modules is illustrated in the figure below.



**Figure 7: Power-up Timing (EC2x Series)**

The power-up timing of EC200x and EC2x series modules is illustrated in the table below.

**Table 7: Power-up Timing of EC200x and EC2x Series**

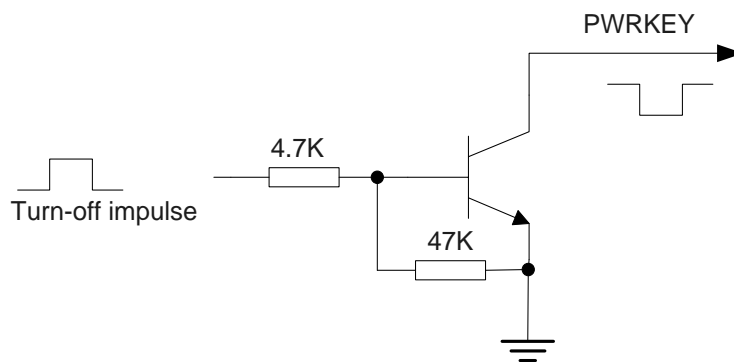
Module	T <sub>1</sub>	T <sub>2</sub>	T <sub>3</sub>	T <sub>4</sub>	T <sub>5</sub>	T <sub>6</sub>	T <sub>7</sub>
EC200U Series	$\geq 2 \text{ s}$	Approx. 1.15 s	-	-	$\geq 5.05 \text{ s}$	$\geq 4 \text{ s}$	$\geq 2.23 \text{ s}$
EC200T Series	$\geq 500 \text{ ms}$	Typ. 5 ms	$\geq 100 \text{ ms}$	Typ. 22 ms	$\geq 10 \text{ s}$	$\geq 10 \text{ s}$	$\geq 10 \text{ s}$
EC200S Series	$\geq 500 \text{ ms}$	Typ. 5 ms	$\geq 100 \text{ ms}$	Typ. 22 ms	$\geq 10 \text{ s}$	$\geq 10 \text{ s}$	$\geq 10 \text{ s}$
EC25 Series/ EC21 Series/ EC20-CE	$\geq 500 \text{ ms}$	Typ. 100 ms	$\geq 200 \text{ ms}$	-	$\geq 2.5 \text{ s}$	$\geq 12 \text{ s}$	$\geq 13 \text{ s}$

**NOTE**

1. Make sure that VBAT is stable and wait at least 30 ms before pulling down PWRKEY pin.
2. PWRKEY can be pulled down directly to GND with a recommended resistor if the module needs to be powered on automatically and shutdown is not needed. EC200T & EC200S series pull-down resistors should be 4.7 kΩ; EC2x series pull-down resistor should be 10 kΩ, and EC200U series pull-down resistor should be 1 kΩ.
3. EC200U series STATUS pin is not OD pin but DO pin, and outputs high-level after T<sub>5</sub> (5.05 s).
4. EC200T/EC200S series RESET\_N pin should be pulled up after pulling down the PWRKEY pin, and EC200U series & EC2x series RESET\_N pin should be pulled up after the VBAT pin is powered on.

**4.2.2. Turn-off**

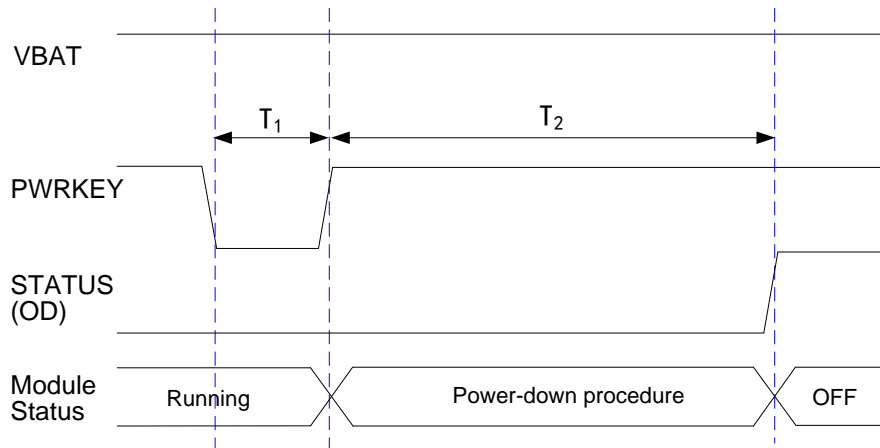
The following is a reference design of the turn-off circuits for EC200x and EC2x series modules.



**Figure 8: Turn-off Circuit**

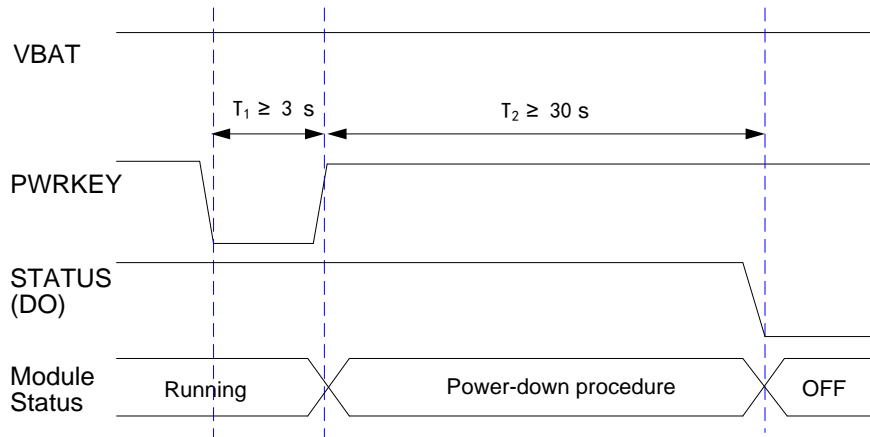
**4.2.2.1. Turn off with PWRKEY**

The power-off scenario of EC200T series, EC200S series and EC2x series modules is illustrated in the figure below.



**Figure 9: Power-off Timing (EC200T & EC200S & EC2x Series)**

The power-off scenario of EC200U series module is illustrated in the figure below.



**Figure 10: Power-off Timing (EC200U Series)**

The power-off timing with PWRKEY of EC200x and EC2x series modules is illustrated in the table below.

**Table 8: Power-off Timing by PWRKEY on EC200x and EC2x Series**

Module	$T_1$	$T_2$
EC200U Series	$\geq 3\text{ s}$	$\geq 30\text{ s}$
EC200T Series	$\geq 650\text{ ms}$	$\geq 2\text{ s}$
EC200S Series	$\geq 650\text{ ms}$	$\geq 2\text{ s}$
EC25 Series/EC21 Series/EC20-CE	$\geq 650\text{ ms}$	$\geq 29.5\text{ s}$

**4.2.2.2. Turn off with AT Command**

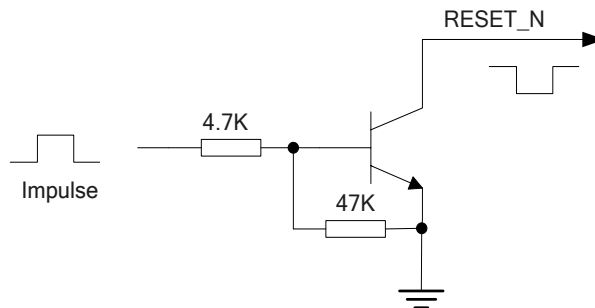
The module can also be safely turned off with **AT+QPOWD**, which is similar to turning off the module via PWRKEY pin. See **documents [7] & [8] & [9]** or more information about **AT+QPOWD**.

**NOTE**

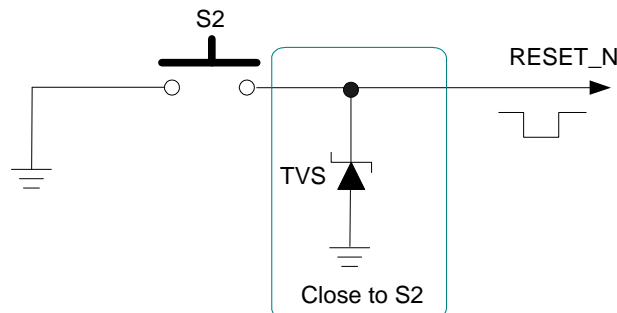
1. To avoid damaging the internal flash, do not switch off the power supply when the module is working normally. Only after the module is shut down with PWRKEY or AT command, the power supply can be cut off.
2. When turning off module with the AT command, keep PWRKEY at high level after executing the command. Otherwise, the module will turn on again after being turned off.

**4.3. Reset**

Use RESET\_N only in case of failure to turn off the module with **AT+QPOWD** or PWRKEY pin. A reference design for EC200x and EC2x series module reset signal circuit is presented in the figures below.

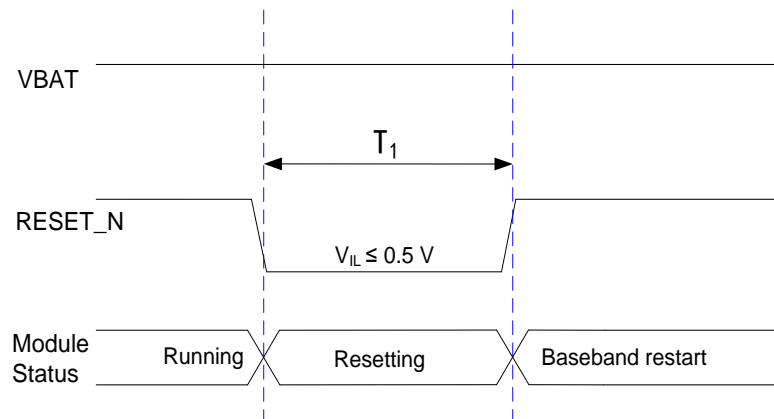


**Figure 11: Reset Signal Circuit**

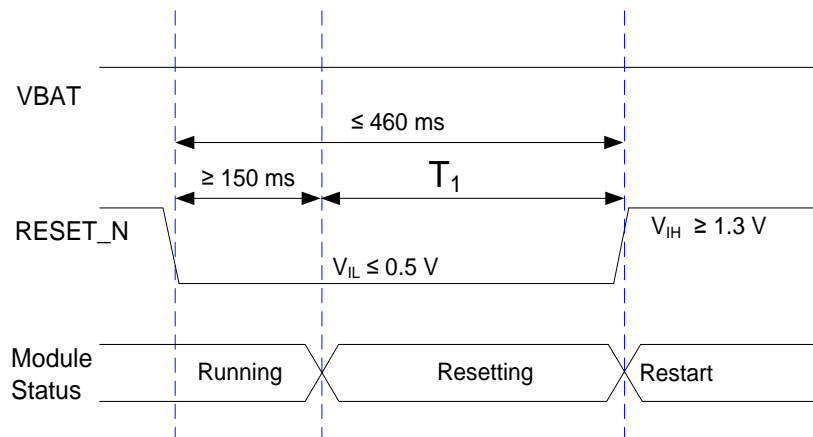


**Figure 12: Reset Signal Circuit with Push Button**

The reset scenario of EC200x and EC2x series modules are illustrated in the figures below.



**Figure 13: Reset Timing (EC200x Series)**



**Figure 14: Reset Timing (EC2x Series)**

The reset timing of EC200x and EC2x series modules is presented in the table below.

**Table 9: Reset Timing of EC200x and EC2x Series**

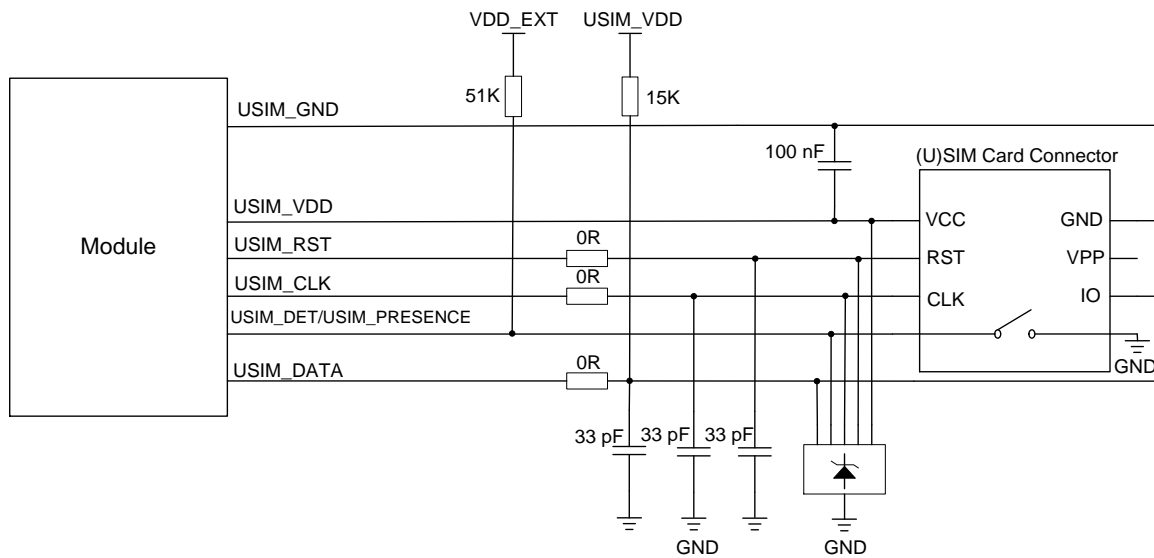
Module	T <sub>1</sub>
EC200U Series	≥ 100 ms
EC200T Series	≥ 300 ms
EC200S Series	≥ 300 ms
EC25 Series/EC21 Series/EC20-CE	150 ms ≤ T <sub>1</sub> ≤ 460 ms

**NOTE**

1. EC200x series RESET\_N pin only resets the baseband chip inside the module, and does not reset the power management chip. EC20-CE series RESET\_N pin can reset the power management chip.
2. When the RESET\_N pin on EC200S series and EC200T series modules is pulled down, the baseband chip is in the reset state, and the chip system restarts after the pin is released.
3. Ensure that the load capacitance does not exceed 10 nF on PWRKEY and RESET\_N pins.

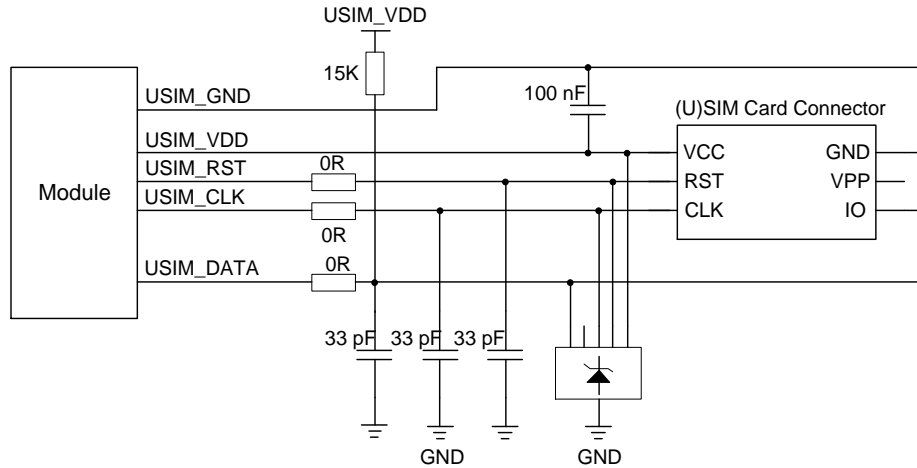
### 4.4. (U)SIM Interface

(U)SIM interface of EC200x and EC2x series module meets ETSI and IMT-2000 requirements. Both 1.8 V and 3.0 V (U)SIM cards are supported. The reference design of the (U)SIM interface with an 8-pin (U)SIM card connector is presented in the figure below.



**Figure 15: Reference Design of (U)SIM Interface with an 8-Pin (U)SIM Card Connector**

If (U)SIM card detection function is not needed, please keep USIM\_DET/USIM\_PRESENCE unconnected. The reference design of (U)SIM interface with a 6-pin (U)SIM card connector is presented in the figure below.



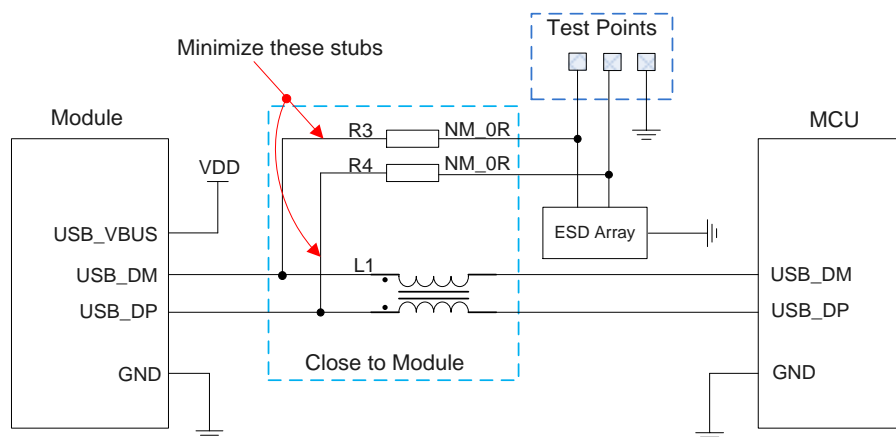
**Figure 16: Reference Design of (U)SIM Interface with a 6-Pin (U)SIM Card Connector**

### 4.5. USB Interface

EC200x and EC2x series modules contain one integrated Universal Serial Bus (USB) interface that complies with USB 2.0 specification, supports high-speed (480 Mbps) and full-speed (12 Mbps) modes.

The USB interface of these modules can only be a slave device and is used for AT command communication, data transmission, GNSS NMEA sentence output<sup>9</sup>, software debugging and firmware upgrading.

The USB interface should be reserved for firmware upgrading in customers' design. The reference design of USB interface is presented in the figure below.



**Figure 17: USB Interface Implementation**

<sup>9</sup> The USB interface does not support GNSS NMEA sentence output for EC200x series modules.

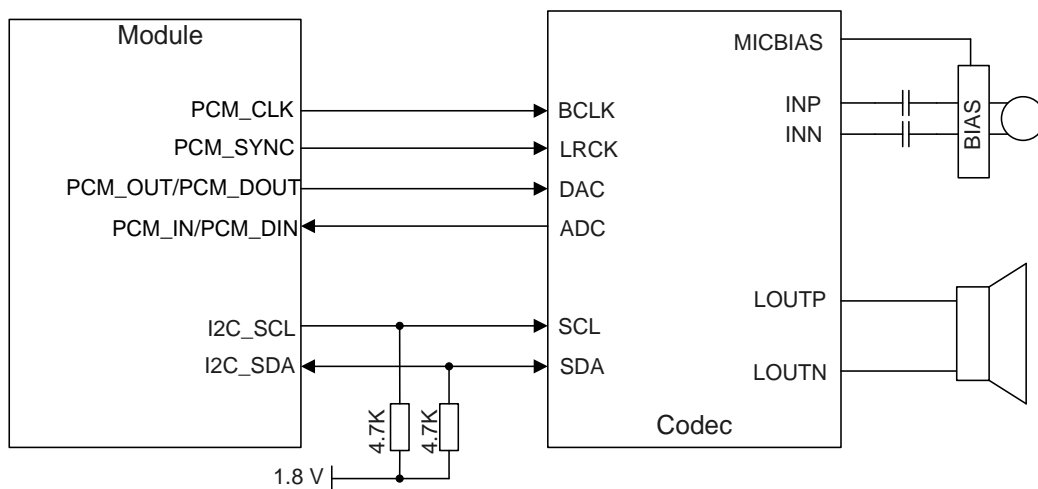


A common mode choke L1 should be added in series between the module and your MCU to suppress EMI spurious emission. 0 Ω resistors (R3 and R4) should be added in series between the module and the test points to facilitate debugging, since the resistors are not mounted by default. To ensure USB data signal integrity, L1, R3 and R4 components must be placed close to the module, and R3 and R4 resistors should be placed close to each other, as well. Stubs should be avoided on all traces if possible, if not, they must be as short as possible.

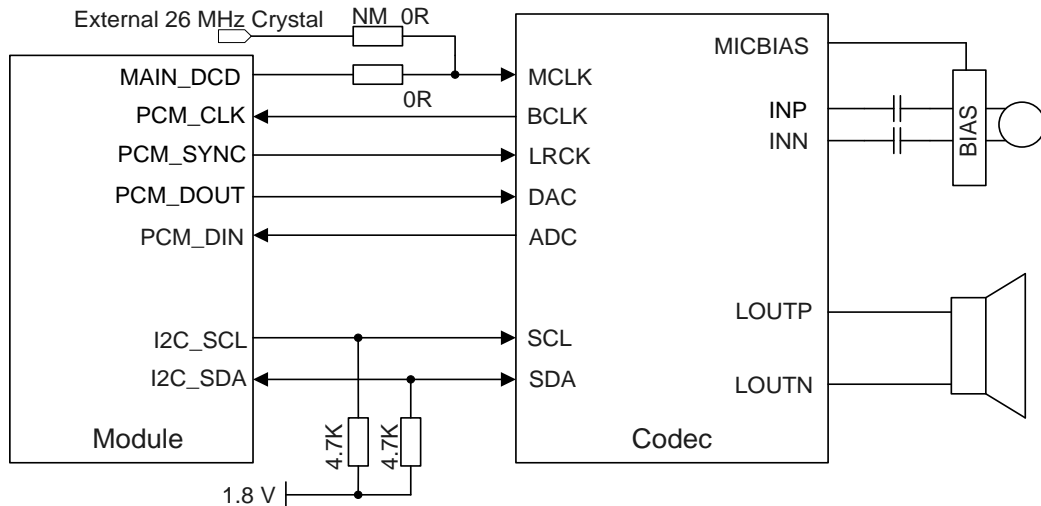
### 4.6. PCM and I2C Interfaces

EC200x and EC2x series modules support one PCM interface for audio applications and one I2C interface.

Reference design of EC200T series, EC200S series and EC2x series PCM and I2C interfaces with external codec IC is presented below.



**Figure 18: Reference Design of PCM and I2C Application with Audio Codec**



**Figure 19: Reference Design of PCM and I2C Application with Audio Codec (EC200U Series)**

**NOTE**

1. Reserve RC (R = 22 Ω, C = 22 pF) circuits on PCM traces, especially for PCM\_CLK, and close to codec.
2. EC200T series, EC200S series and EC2x series modules are I2C master devices. EC200U series can only be used as master devices, not slave devices.

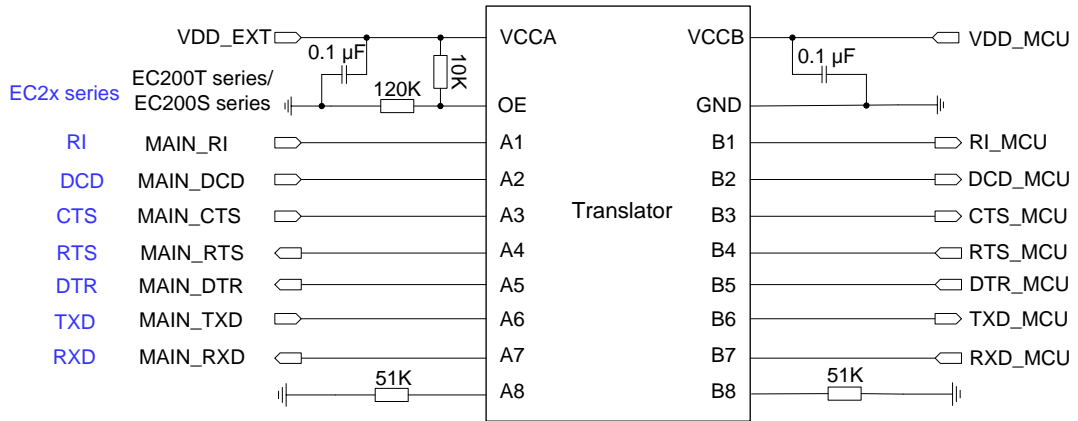
### 4.7. UART Interfaces

EC200x and EC2x series modules support one main UART and one debug UART interface. (EC200U series also supports an auxiliary UART interface.)

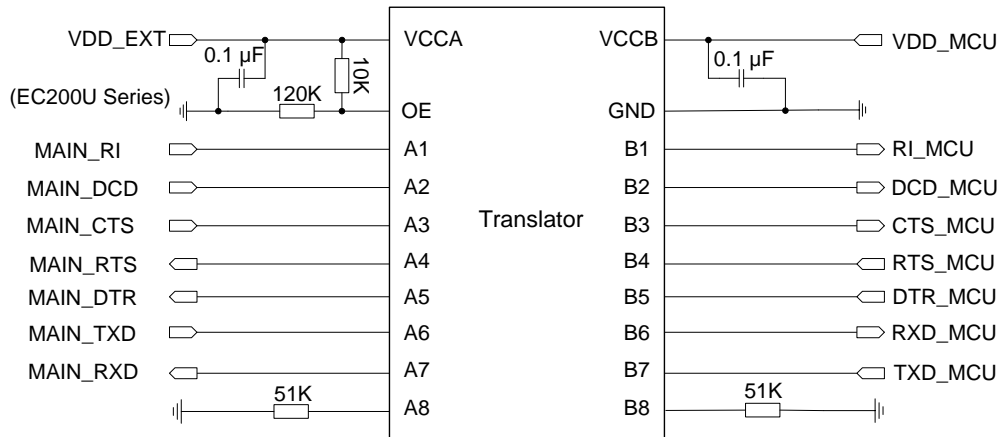
The main UART interface can be used for data transmission and AT command communication. In addition, it supports RTS and CTS hardware flow control.

For EC200T and EC200S series module, the debug UART interface supports 115200 bps baud rate. (EC200U series only supports 921600 bps baud rate.) It is used for partial log output. For EC2x series, the debug UART interface can also be used for Linux console and log output.

EC200x and EC2x series modules have a 1.8 V UART interface. A voltage-level translator should be used if a customers' application has a 3.3 V UART interface. Voltage-level translator TXS0108EPWR provided by *Texas Instrument* is recommended. The voltage-level translator reference design with IC is presented below.



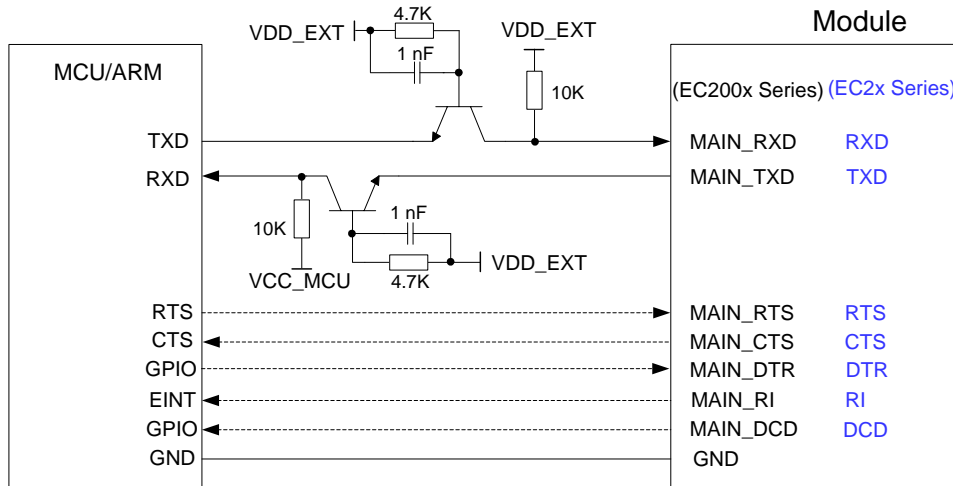
**Figure 20: Voltage-level Translator Reference Design with IC (EC200T/EC200S Series)**



**Figure 21: Voltage-level Translator Reference Design with IC (EC200U Series)**

Visit <http://www.ti.com> for more information.

Another example of a voltage-level translator reference design with transistor is shown below. The reference design of the two signals presented in solid lines also applies to the other signals presented in dotted lines (the signals are presented in dotted lines to simplify the illustration). Please pay attention to signal directions.



**Figure 22: Voltage-level Translator Reference Design with Transistors**

**NOTE**

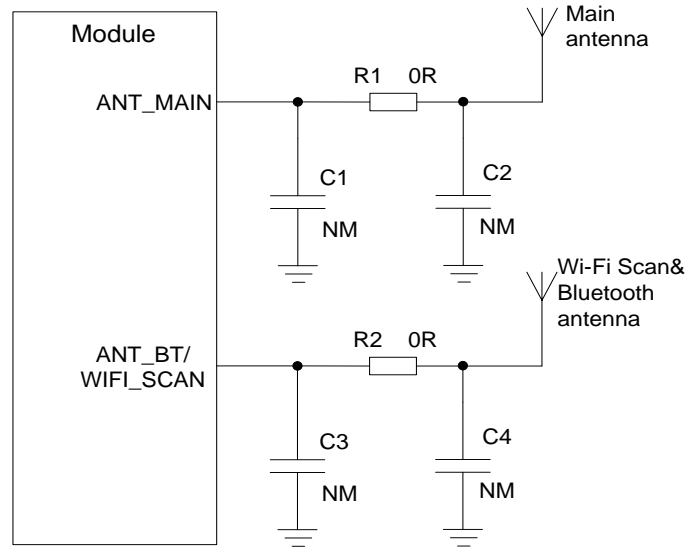
1. The solution implementing transistor circuit is not suitable for applications with high baud rate exceeding 460 kbps.
2. Please note that the module CTS is connected to the host CTS, and the module RTS is connected to the host RTS.

## 4.8. Antenna Interfaces

### 4.8.1. RF Antenna Interface

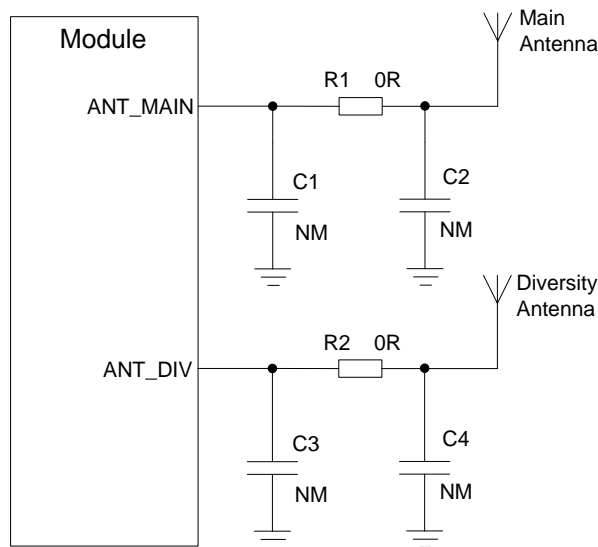
The ANT\_MAIN pins on EC200x and EC2x series modules are compatible. The impedance of RF antenna interface is 50 Ω. For better RF performance, a π-type matching circuit should be reserved, and the π-type matching components should be placed as close to the antenna as possible.

In addition to supporting the main antenna, EC200U series also supports the Wi-Fi Scan & Bluetooth antenna. The two functions cannot be used simultaneously because they share the same antenna interface. And Wi-Fi scan only supports reception. A reference design of ANT\_MAIN and ANT\_BT/WIFI\_SCAN is shown below. A π-type matching circuit should be reserved for better RF performance. The capacitors are not mounted by default.



**Figure 23: Reference Design of RF Antenna Interface (EC200U Series)**

EC200T series and EC2x series modules support Rx-diversity function via ANT\_DIV interface. A reference design for ANT\_DIV antenna interface of EC200T series and EC2x series modules is shown below.



**Figure 24: Reference Design of RF Antenna Interface (EC200T & EC2x Series)**

EC200S series supports main antenna and Wi-Fi scan antennas. They share the same antenna interface (except for EC200S-EN, which does not support Wi-Fi scan antenna. A reference design of ANT\_MAIN is shown below.

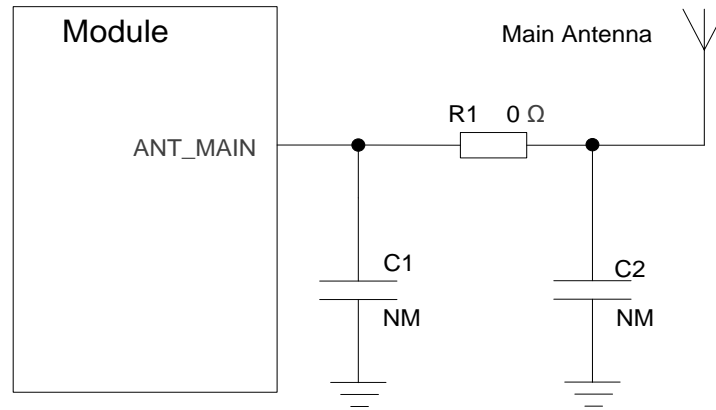


Figure 25: Reference Design of RF Antenna Interface (EC200S Series)

**NOTE**

1. To improve receiving sensitivity, it is necessary to ensure the proper distance between the main antenna and the Bluetooth receiving antenna/Rx-diversity antenna.
2. Place the  $\pi$ -type matching components (R1 & C1 & C2 and R2 & C3 & C4) as close to the antenna as possible.

**4.8.2. GNSS Antenna Interface**

EC200U series, EC25 series, EC21 series, and EC20-CE modules support GNSS antenna, with ANT\_GNSS pin provided. A reference design of ANT\_GNSS antenna interface of EC2x series is shown below.

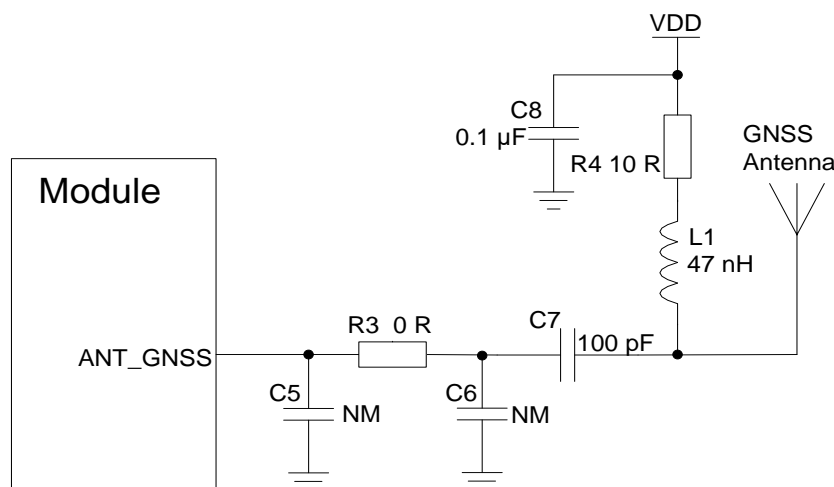
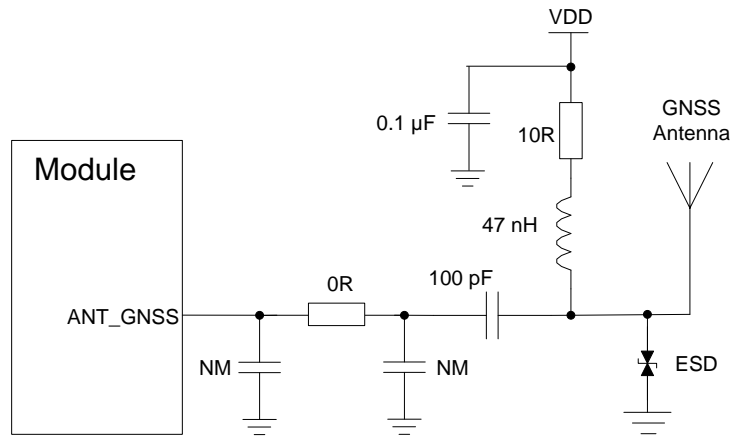
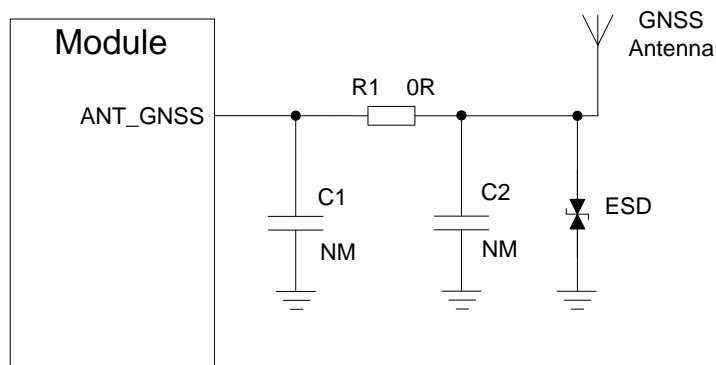


Figure 26: Reference Design of GNSS Antenna Interface (EC200U & EC2x Series)

EC200S-CN with built-in GNSS function can support the active GNSS antenna and passive GNSS antenna. The power supply voltage range of the external active antenna is 2.8–4.3 V, and the typical value is 3.3 V.



**Figure 27: Active GNSS Antenna Reference Design**



**Figure 28: Passive GNSS Antenna Reference Design**

It is recommended to reserve C1, R1 and C2 for adjusting antenna impedance. C1 and C2 are not mounted by default, and R1 is only mounted with a 0 Ω resistor. The impedance of the RF trace should be controlled at about 50 Ω, and the trace should be as short as possible.

**NOTE**

1. An external LDO can be selected to supply power according to the active antenna requirement.
2. If the module is designed with a passive antenna, then the VDD circuit is not needed.
3. For EC200S series, the junction capacitance of antenna interface ESD device should be less than 0.05 pF.

# 5 Recommended Footprints

The recommended compatible footprint of EC200x and EC2x series modules is shown in the following figure. All dimensions are in mm, and the dimensional tolerances are  $\pm 0.2$  mm unless otherwise specified.

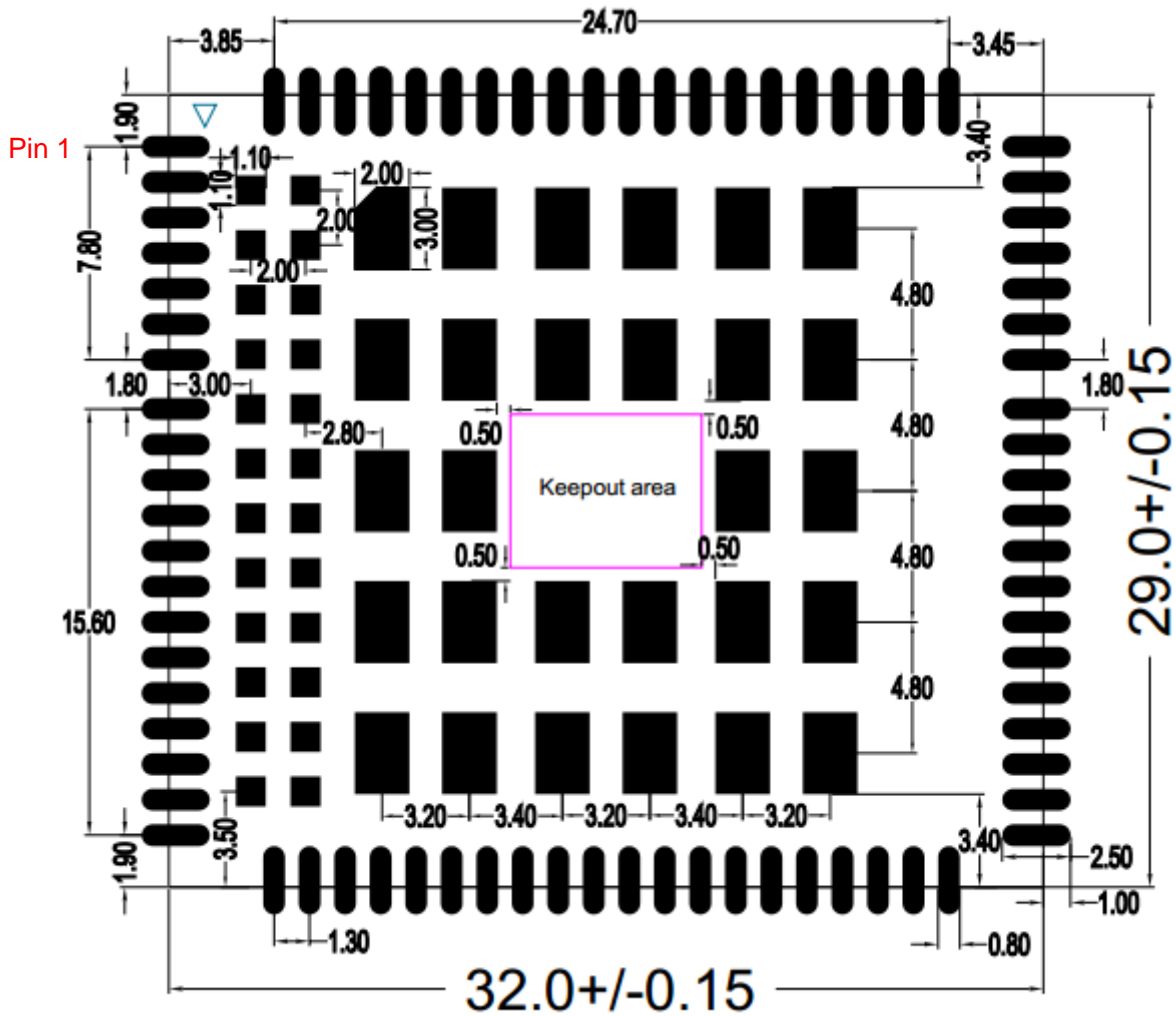
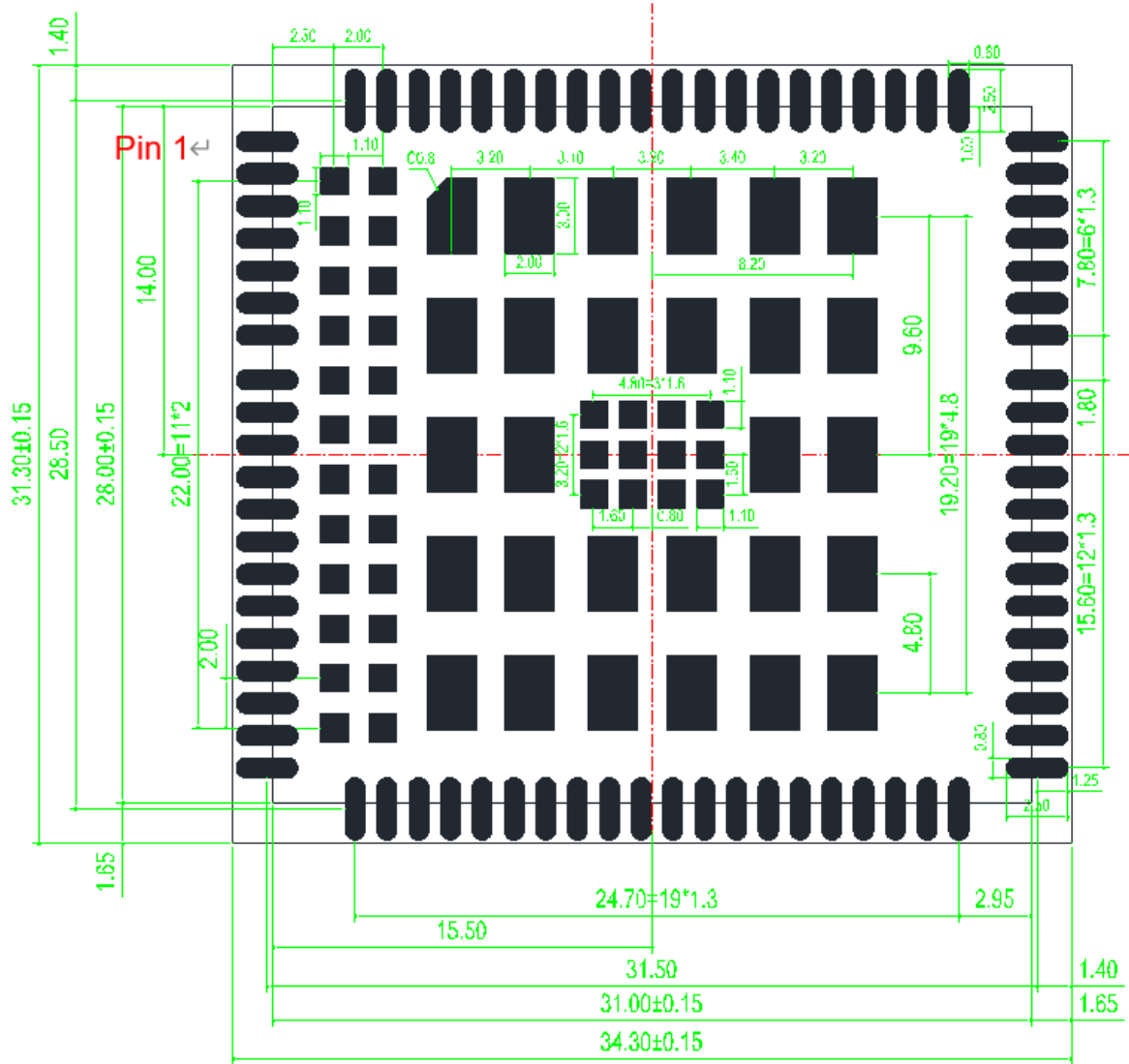


Figure 29: Recommended Compatible Footprint (EC200T & EC200S & EC2x Series)





**Figure 30: Recommended Compatible Footprint (EC200U Series)**

If SGMII or Wi-Fi function (supported by EC2x series) is not needed, clear the keepout area for pins 117–140 in the compatible design. The recommended compatible footprint without SGMII or Wi-Fi function is presented in the figure below.

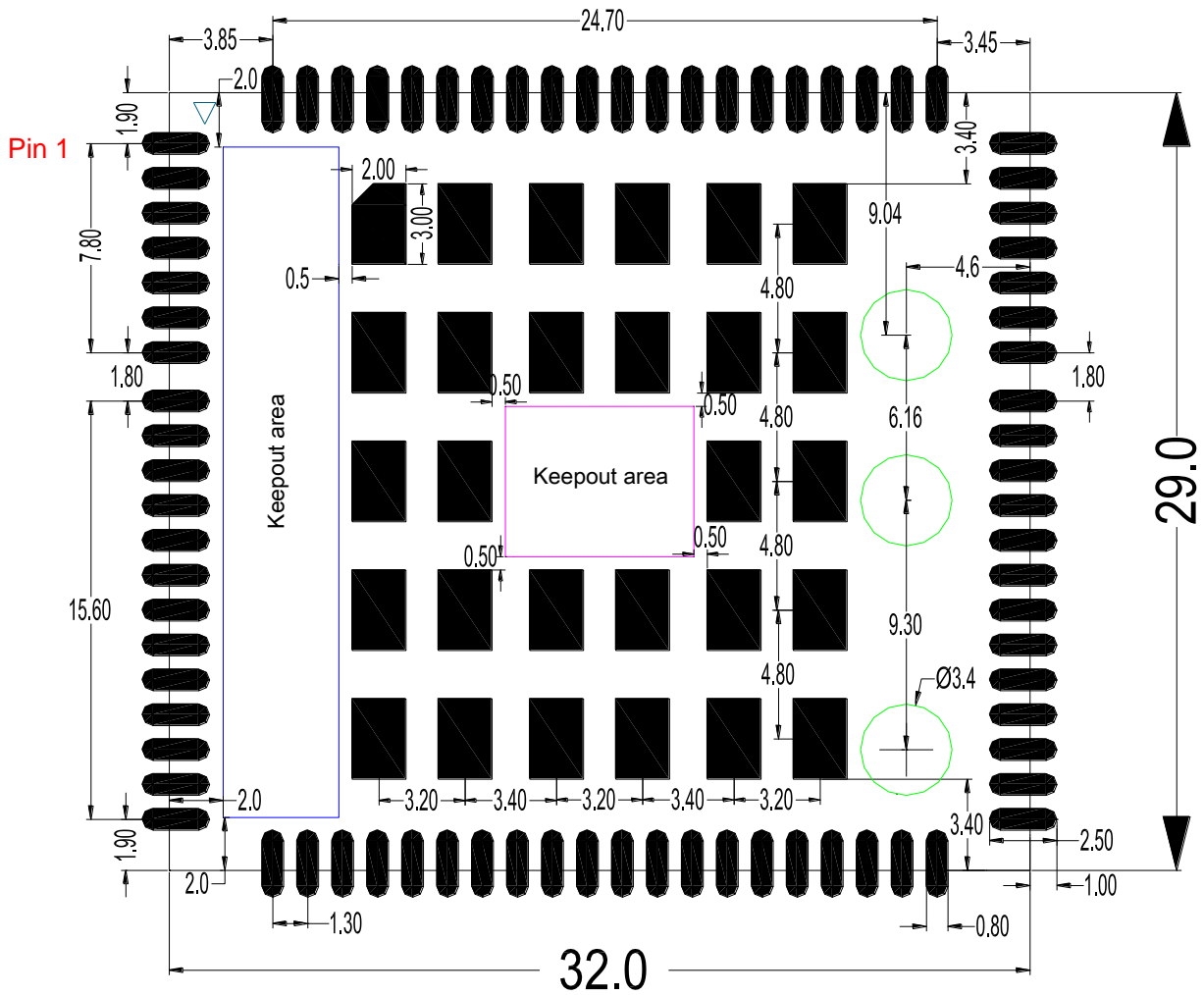


Figure 31: Recommended Compatible Footprint Without SGMII or Wi-Fi Function

**NOTE**

1. Do not design the keepout area marked in purple. In addition, clear the keepout area marked in blue for pins 117–140 if SGMII or Wi-Fi function is not needed.
2. For convenient module maintenance, keep about 3 mm between the module and other components in the motherboard.

# 6 Appendix References

**Table 10: Related Documents**

Document Name
[1] Quectel_EC200U_Series_Hardware_Design
[2] Quectel_EC200T_Series_Hardware_Design
[3] Quectel_EC200S_Series_Hardware_Design
[4] Quectel_EC25_Series_Hardware_Design
[5] Quectel_EC21_Series_Hardware_Design
[6] Quectel_EC20_R2.1_Hardware_Design
[7] Quectel_ECx00U&EGx00U_Series_AT_Commands_Manual
[8] Quectel_EC200x&EG912Y&EC600S_Series_AT_Commands_Manual
[9] Quectel_EC2x&EG9x&EG2x-G&EM05_Series_AT_Commands_Manual
[10] Quectel_EC200U_Series_Reference_Design
[11] Quectel_EC200T_Series_Reference_Design
[12] Quectel_EC200S_Series_Reference_Design
[13] Quectel_EC25_Reference_Design
[14] Quectel_EC21_Reference_Design
[15] Quectel_EC20_R2.1_Reference_Design

**Table 11: Terms and Abbreviations**

<b>Abbreviation</b>	<b>Description</b>
bps	Bits Per Second
CDMA	Code-Division Multiple Access
CTS	Clear to Send
DCS	Data Coding Scheme
DFOTA	Delta Firmware Upgrade Over-The-Air
DL	Downlink
DTR	Data Terminal Ready
EGSM	Enhanced GSM
EMI	Electromagnetic Interference
ESD	Electrostatic Discharge
EVDO	Evolution-Data Optimized
FDD	Frequency Division Duplex
Galileo	Galileo Satellite Navigation System (EU)
GLONASS	Russian Global Navigation Satellite System
GND	Ground
GNSS	Global Navigation Satellite System
GPIO	General Purpose Input/Output Pin
GPS	Global Positioning System
GRFC	Generic RF Control
GSM	Global System for Mobile Communications
HSPA	High Speed Packet Access
I2C	Inter-Integrated Circuit
IC	Integrated Circuit

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I/O	Input/Output
LCC	Leadless Chip Carrier
LCD	Liquid Crystal Display
LDO	Low-dropout Regulator
LGA	Land Grid Array
LTE	Long Term Evolution
MCU	Microcontroller Unit/Microprogrammed Control Unit
NMEA	NMEA (National Marine Electronics Association) 0183 Interface Standard
QZSS	Quasi-Zenith Satellite System
RF	Radio Frequency
RTS	Real-Time Clock
SDIO	Secure Digital Input/Output
SGMII	Serial Gigabit Media Independent Interface
SMS	Short Message Service
SPI	Serial Peripheral Interface
TDD	Time Division Duplexing
TD-SCDMA	Time Division-Synchronous Code Division Multiple Access
TVS	Transient Voltage Suppressor
UART	Universal Asynchronous Receiver/Transmitter
UL	Uplink
UMTS	Universal Mobile Telecommunications System
USB	Universal Serial Bus
(U)SIM	(Universal) Subscriber Identity Module
VDD	Drain Voltage
$V_{rwm}$	Reverse Working Maximum Voltage

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WCDMA	Wideband Code Division Multiple Access
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Wi-Fi	Wireless Fidelity
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WLAN	Wireless Local Area Network
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